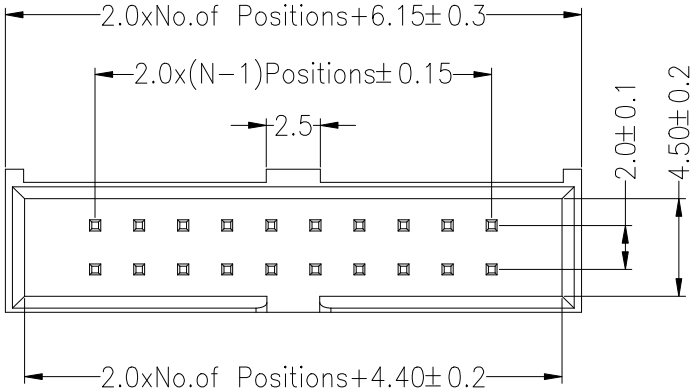
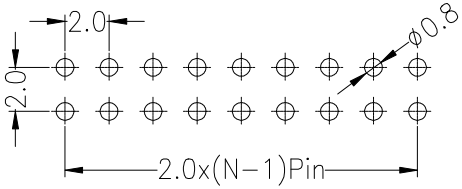
HSF RoHS

SPECIFICATIONS
Rated Current:2.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: LCP
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



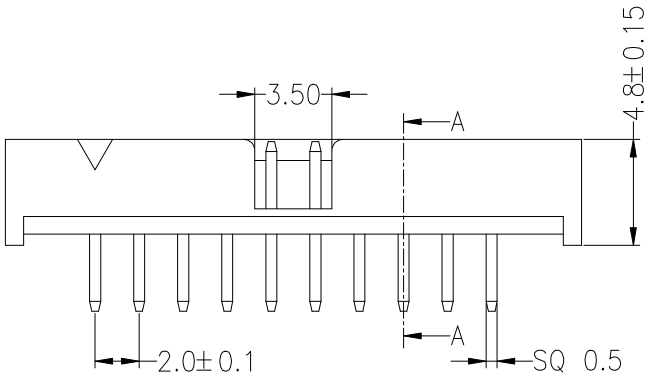
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE± 0.05)

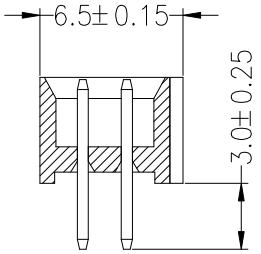


Ordering Information

3224 XX S XX X B K00 X 0X

- XX: No.of Pins 6−−64
- XX: Contact Plating
  G0:Gold Flash
  G1:1U" Gold
  G2:1.5U" Gold
  G3:2U" Gold
  G4:3U" Gold
  G5:5U" Gold
  S0:Gold Flash/Tin
- X: Insulator Material Option
  A=BK−PBT
  C=BK−PA6T
  D=BK−PA46
  E=BK−PA9T
  F=BK−LCP
- X: Packing
  0=PE Bag
  A=Tray
  T=Tube
  P=Tube+Cap
  R=Reel+Cap





SECTION A−A

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2015.04.18	NEW DRAWING	

OPERATION	
X.X	± 0.30
X.XX	± 0.20
X.XXX	± 0.10
Angle	± 3°
DIM	TOL

DRAW	Liu Miao	15.04.18
CHECK		
APPROVE		

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司 SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	3224XXSXXXBK00X0X
TITLE:	2.0Box Header Npin H4.8 180°